

製品 仕様 書 Product Specification

3M 印 MDR ボードマウント リセプタクル ライトアングルタイプ 102XX-52XX PX

3M Brand MDR Board Mount Receptacle Right Angle Type 102XX-52XX PX

APRV. Thinan 8/17 2004 CHKD. 75/10/21 8/17 2004 PRPD. 7. Nagune 8/17, 2004

SUMITOMO 3M LIMITED

ELECTRONIC SOLUTIONS DIVISION TECHNICAL DEPARTMENT

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1. FUNCTION

This connector is one of MDR board mount receptacle right angle series. And mating side has 2 rows of female contacts with the pitch of 1.27mm and contact tails are arranged in 1.27mm×1.905mm staggered grid. This connector can be mounted on the compatible PC board and mating with MDR plug connector enable to have the electrical performance.

2. COMPATIBLE OBJECTS

2-1 COMPATIBLE CONNECTORS

3M BRAND MDR PLUG: 101XX-XXXX XX

2-2 COMPAIBLE PC BOARDS

PCB with solder plating hole

See RELATED SPECIFICATION DRAWINGS recommended hole pattern.

PRODUCT No.	PCB RETENSION METHOD	PCB RETENSION HOLE DIA.	PCB THICKNESS	
102XX-520X XX		128	3.9 mm Tail: 3.0 mm Max.	
102XX-521X XX	SCREW LOCK	φ 2.8 mm	2.8 mm Tail: 1.6 mm Max.	
102XX-524X XX		ф 3.2 mm	2.3 mm Tail: 1.2 mm Max.	
102XX-52AX XX		ф 2.6 mm	1.6 mm	
102XX-52BX XX	GROUND LOCK TYPE1			
102XX-52EX XX				
102XX-52DX XX	GROUND LOCK TYPE2	ф 2.8 mm	0.6 mm or 1.2 mm	
102XX-52FX XX				
102XX-52GX XX	GROUND LOCK TYPE3	φ 2.8 mm (recommended) or φ 2.6 mm	0.6 mm Min. 1.6 mm Max.	
102XX-52HX XX				

2-3 COMPATIBLE PANELS

Thickness of panels: 2.0 mm Max. (Including with the thickness of washers)
See RELATED SPECIFICATION DRAWINGS for recommended panel cut-out.

3. RELATED SPECIFICATION DRAWINGS

See the drawings described in JNPD-0813.

4. RELATED TEST STANDARDS

MIL-STD-202 JEIDA-38-1984

ЛЅ С 0050

JNTM-0039, JNTM-0040

*JNTM: Test Method Standard of Sumitomo 3M for Electronic and Electrical Component Parts.

5. APPLICATION PRODUCT NUMBER INFORMATION - PLATING THICKNESS SUFFIX PL: under Nickel Plating CONTACT AREA / Gold Plating 0.2 µm Min. TAIL AREA / Gold Flash Plating with Lubricant Treatment PE: under Nickel Plating CONTACT AREA / Gold Plating 0.5 µm Min. TAIL AREA / Gold Flash Plating PC: under Nickel Plating CONTACT AREA / Gold Plating 0.76 µm Min. **SOLDER TAIL** TAIL AREA / Gold Flash Plating 2:3.9mm 3:2.8mm 4:2.3mm **RETENTION FEATURE** 0 : Lock Stand (M2.6mm) for Panel and Screw Lock (M2.6) for PC Board : Lock Stand (M2.5mm) for Panel and Screw Lock (M2.5) for PC Board : Lock Stand (No.4-40) for Panel and Screw Lock (No.4-40) for PC Board A : Lock Stand (M2.6mm) for Panel and Ground Lock Type 1 for PC Board B : Lock Stand (M2.5mm) for Panel and Ground Lock Type 1 for PC Board $D \quad : \ Lock \ Stand \ (M2.6mm) \ for \ Panel \ and \ Ground \ Lock \ Type \ 2 \ for \ PC \ Board$ E: Lock Stand (No.4-40) for Panel and Ground Lock Type 1 for PC Board : Lock Stand (M2.6mm) for Panel and Ground Lock Type 3 for PC Board G: Lock Stand (M2.5mm) for Panel and Ground Lock Type 3 for PC Board H: Lock Stand (No.4-40) for Panel and Ground Lock Type 3 for PC Board **TYPE** 2 : Standard Body PIN CONFIGURATIONS 5 : Board Mount Right Angle Type **CONTACT QUANTITY** XX: XX Pos. (Exception: 100 pos. is shown "A0".) PRODUCT SERIES NAME 102: MDR Receptacle

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6. QUALITY PERFORMANCE

6-1 RATING

ITEM	RATING	
CURRENT	0.5A Max.	
VOLTAGE	AC: 150V Max. / DC: 200V Max.	
TEMPERATURE	-55°C ~ 85°C	

6-2 PHYSICAL SPECIFICATIONS

* The value in () is reference.

TEST DESCRIPTION	REQUIREMENT	TEST CONDITION	RELATED STANDARD
CONTACT RETENTION FORCE	7.85N (0.8 kgf) Min.	Tensile speed 5mm / min.	
INSERTION & WITHDRAWAL FORCE	Insertion Force: 1.47N (150 gf) Max. Withdrawal Force: 0.39N (40 gf) Min.	Tensile speed 5mm / min with Compatible connector. Spec. Value is estimated by one contact pin.	
CONTACT SOLDER ABILITY	Wetting: 95% Min. or Zero cross time: 3 seconds Max.	Solder: Sn-3Ag-0.5Cu - Wetting Measurement: 245°C, 3 seconds - Wetting Balance Method: 245°C	JNTM-0039 JIS C 0050
Connector should not have any defect portions after test. SOLDERING HEAT RESISTANCE		Dip soldering: 260°C, 10 seconds, 2 times or 263°C, 5 seconds, 2 times * Pre-heat Condition: Temp. of Components 100°C Max. Duration 60 seconds Max. Soldering iron: 390°C, 3 seconds, 2 times	JNTM-0040

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6-3 ELECTRICAL SPECIFICATIONS

TEST DESCRIPTION	REQUIREMENT	TEST CONDITION	RELATED STANDARD
DIELECTRIC WITHSTANDING VOLTAGE	No appearance of arcing and break down. Leak current: 1mA Max.	Impressed voltage is AC 500V rms. between adjacent two contacts for one minute.	
INSULATION RESIDENSE	500MΩ Min.	Impressed voltage is DC 500V between adjacent two contacts for one minute.	
DISCONTINUITY	Less than 1µs	- Vibration test * as the part of 3M SEQUENCE-II - Mechanical sock test	See Table 1.
CONTACT RESISTANCE	Initial / for each plating spec. $35 m\Omega$ Max. Change of contact resistance after evaluation tests/ for each plating spec. $\pm 25 m\Omega$ Max.	Contact resistance is measured at Short Circuit. Current: 1.5mA Open Circuit Voltage: 20mV by 4 terminal method. * Measurement values include the resistance of contact pins as conductive material. (1) PL Plating 3M SEQUENCE -I/ mating (30 cycles) → moisture → salt spray 3M SEQUENCE -II / thermal shock → humidity → vibration 3M SEQUENCE -III / thermal life H ₂ S GAS SEQUENCE / mating (30 cycles) → H ₂ S gas DURABILITY / 300 cycles MECHANICAL SHOCK / (2) PE Plating and PC Plating 3M SEQUENCE -I / mating (50 cycles) → moisture → salt spray 3M SEQUENCE -II / thermal shock → humidity → vibration 3M SEQUENCE -III / thermal shock → humidity → vibration 3M SEQUENCE -III / thermal life H ₂ S GAS SEQUENCE / mating (50 cycles) → H ₂ S gas DURABILITY / 500 cycles * NOTE: See Table 1. for environmental tests.	See Table 1.

Table 1: ENVIROMENTAL TEST

ITEM	TEST CONDITION	RELATED STANDARD	
MOISTURE	-10 ~ 65°C, Relative Humidity 95% / 10 cycles	MIL-STD-202F106D	
SALT SPRAY	NaCl 5% solution, 35°C / 48 hours	MIL-STD-202F101D	
THERMAL SHOCK	-55°C→25°C→85°C→25°C / 5 cycles	MIL-STD-202F107G	
HUMIDITY (STEADY STATE)	40°C, Relative Humidity 95% / 96 hours	MIL-STD-202F103B	
THERMAL LIFE	Steady Current: Current Rating × 110%, 85°C / 1000 hours		
H ₂ S GAS	3 ± 1 ppm, 40 °C, Relative Humidity $70 \sim 80\% / 96$ hours	JEIDA-38-1984	
VIBRATION	Sweep Freq.: 10 ~ 55Hz, Amplitude: 1.52mm (or 98 m/s²) Sweep Cycle: 1 min., Sweep time: 2 hours Sweep Directions: X, Y, Z	MIL-STD-202F201A	
MECHANICAL SHOCK	490 m/s², 11ms, Half sine shock pulse. 3 times / X,Y,Z directions (Total 9 times)	MIL-STD-202E213B	

7. PLATING SPEC INDICATION ON CONNECTOR

The first letter, in stamped 3 letters on the connector body for lot numbering, identified the following plating specs.

* XX : two alphabet letters

8. PACKAGE & IDENTIFICATION

These products are packed with plastic tray and carton box for transit. Carton box is identified by part number, quantity, maker name and lot number.

9. STORAGE

This products shall be stored in a room, ambient temperature $5 \sim 35$ °C, and ambient humidity $40 \sim 70$ %.

10. ATTENTIONS

10-1 FIXING OF CONNECTOR

The connector should be fixed on panel by screws.